Ref #	Hits	Search Query	DBs	Default Operator	Plurals	Time Stamp
L1	14064	mim or (metal-insulator-metal) or (metal-insulating-metal) or (metal-oxide-metal) or (metal-dielectric-metal)	US-PGPUB; USPAT; USOCR; EPO; JPO; IBM_TDB	OR	ON	2005/11/30 13:30
L2	3744051	anneal\$3 or heat\$3 or thermal\$3	US-PGPUB; USPAT; USOCR; EPO; JPO; IBM_TDB	OR	ON	2005/11/30 13:31
L3	857816	nitrogen or n2 or "n.sub.2"	US-PGPUB; USPAT; USOCR; EPO; JPO; IBM_TDB	OR	ON	2005/11/30 13:31
L4	616955	(bottom or lower) near2 (electrode\$1 or plate\$1 or layer\$1)	US-PGPUB; USPAT; USOCR; EPO; JPO; IBM_TDB	OR	ON	2005/11/30 13:32
L5	672552	(top or upper) near2 (electrode\$1 or plate\$1 or layer\$1)	US-PGPUB; USPAT; USOCR; EPO; JPO; IBM_TDB	OR	ON	2005/11/30 13:32
L6	27105	(high-k near2 dielectric) or (high near2 dielectric near2 constant)	US-PGPUB; USPAT; USOCR; EPO; JPO; IBM_TDB	OR	ON	2005/11/30 13:33
L7	152436	etch\$3 with (trench\$2 or opening\$1 or hole\$1 or recess\$3 or groove\$1 or via\$1)	US-PGPUB; USPAT; USOCR; EPO; JPO; IBM_TDB	OR	ON	2005/11/30 13:34
L8	325651	2 same 3	US-PGPUB; USPAT; USOCR; EPO; JPO; IBM_TDB	OR	ON	2005/11/30 13:34
L9	2201	4 same 6	US-PGPUB; USPAT; USOCR; EPO; JPO; IBM_TDB	OR	ON	2005/11/30 13:35
L10	2056	5 same 6	US-PGPUB; USPAT; USOCR; EPO; JPO; IBM_TDB	OR	ON	2005/11/30 13:35

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L11	82	1 and 8 and 9 and 10	US-PGPUB; USPAT; USOCR; EPO; JPO; IBM_TDB	OR	ON	2005/11/30 14:29
L12	5208	plasma-free or (plasma near free) or (without near plasma)	US-PGPUB; USPAT; USOCR; EPO; JPO; IBM_TDB	OR	ON	2005/11/30 14:30
L13	170312	cvd or (chemical adj vapor)	US-PGPUB; USPAT; USOCR; EPO; JPO; IBM_TDB	OR	ON	2005/11/30 14:30
L14	212	12 with 13	US-PGPUB; USPAT; USOCR; EPO; JPO; IBM_TDB	OR	ON	2005/11/30 14:30
L15	1	14 and 1	US-PGPUB; USPAT; USOCR; EPO; JPO; IBM_TDB	OR	ON	2005/11/30 14:31
L16	1	5 and 15	US-PGPUB; USPAT; USOCR; EPO; JPO; IBM_TDB	OR	ON	2005/11/30 14:31
L17	9634	thermal\$2 adj2 (13)	US-PGPUB; USPAT; USOCR; EPO; JPO; IBM_TDB	OR	ON	2005/11/30 14:31
L18	323	17 same 5	US-PGPUB; USPAT; USOCR; EPO; JPO; IBM_TDB	OR	ON	2005/11/30 14:31
L19	8	18 and 1	US-PGPUB; USPAT; USOCR; EPO; JPO; IBM_TDB	OR	ON	2005/11/30 14:40
L20	22	mocvd same 17 same ald	US-PGPUB; USPAT; USOCR; EPO; JPO; IBM_TDB	OR	ON	2005/11/30 14:41